Silicon N-Channel Power MOS FET Array

HITACHI

Application

High speed power switching

Features

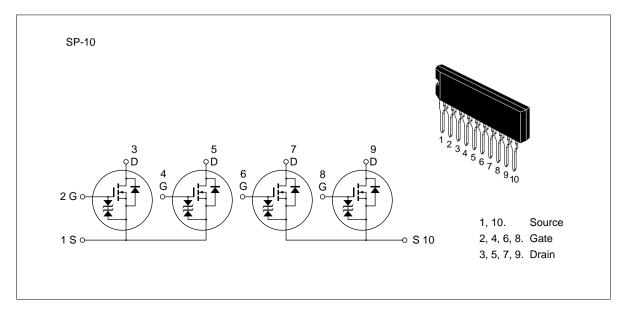
• Low on-resistance

$$R_{DS(on)} \le 0.38$$
 , $V_{GS} = 10$ V, $I_D = 1$ A $R_{DS(on)} \le 0.53$, $V_{GS} = 4$ V, $I_D = 1$ A

- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for motor driver, solenoid driver and lamp driver



Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$) (1 Unit)

Item	Symbol	Rating	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	2.5	Α
Drain peak current	I _{D(pulse)} *1	10	A
Body to drain diode reverse drain current	I _{DR}	2.5	A
Channel dissipation	Pch (Tc = 25°C)*2	28	W
Channel dissipation	Pch*2	4	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

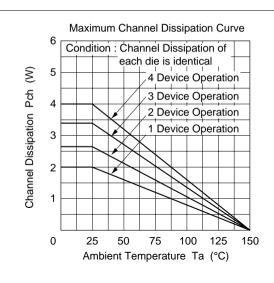
Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

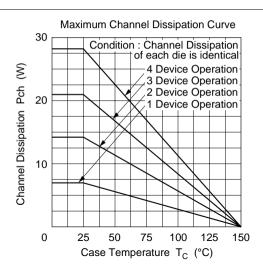
2. 4 devices operation

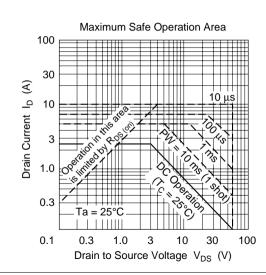
Electrical Characteristics (Ta = 25°C) (1 Unit)

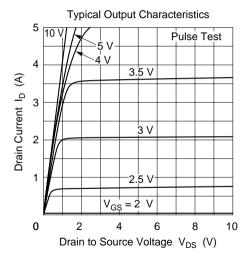
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	100	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\rm GS(off)}$	1.0	_	2.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS(on)}	_	0.25	0.38	Ω	I _D = 1 A V _{GS} = 10 V* ¹
		_	0.40	0.53	Ω	$I_D = 1 A$ $V_{GS} = 4 V^{*1}$
Forward transfer admittance	$ y_{fs} $	1.2	2.0	_	S	$I_D = 1 A$ $V_{DS} = 10 V^{*1}$
Input capacitance	Ciss	_	240	_	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	Coss	_	115	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	35	_	pF	f = 1 MHz
Turn-on delay time	$t_{\text{\tiny d(on)}}$	_	4	_	ns	$I_D = 1 A$
Rise time	t _r	_	15	_	ns	$V_{GS} = 10 \text{ V}$
Turn-off delay time	$t_{\text{d(off)}}$	_	80	_	ns	$R_L = 30 \Omega$
Fall time	t _f	_	40	_	ns	_
Body to drain diode forward voltage	V_{DF}	_	1.0	_	V	$I_F = 2 A, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}		70		ns	$I_F = 2 \text{ A}, V_{GS} = 0$ $dIF/dt = 50 \text{ A}/\mu\text{s}$

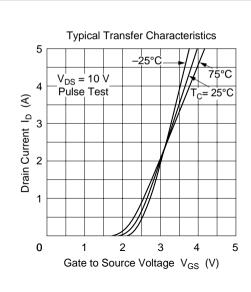
Note: 1. Pulse Test

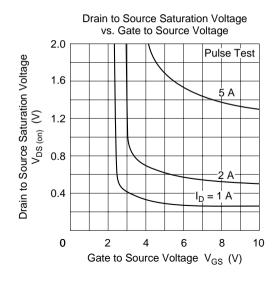


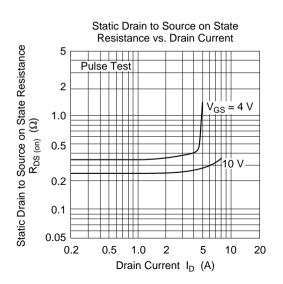


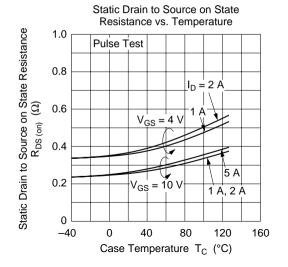


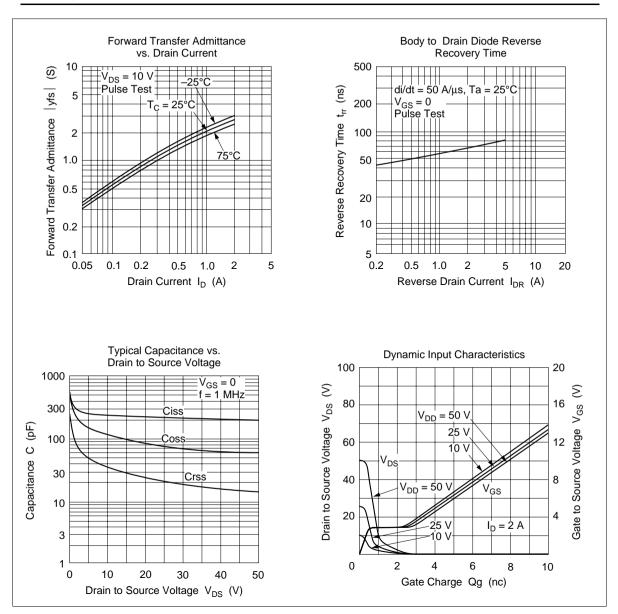


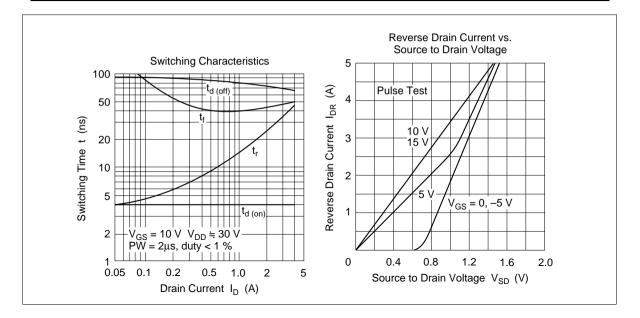




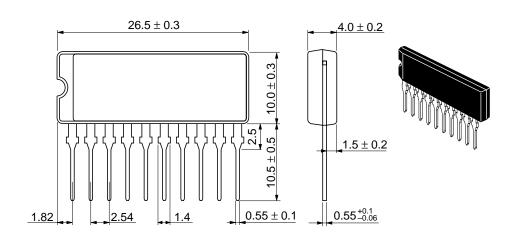








Unit: mm



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Hitachi Code	SP-10
JEDEC	
EIAJ	
Weight (reference value)	2.9 g

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